

12/20/01  
J1130 U.S. PTO

12/28/01

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Docket No.: AB-1169 US

December 20, 2001

Box Patent Application  
Commissioner For Patents  
Washington, D. C. 20231

J1036 U.S. PTO  
10/029165  
12/20/01

Enclosed herewith for filing is a patent application, as follows:

Inventor(s): Cheol Joon Yoo  
Title: Cleaner For Molding Apparatus Of Semiconductor Chip Packages  
X Return Receipt Postcard  
X This Transmittal Letter (in duplicate)  
9 page(s) Specification (not including claims)  
4 page(s) Claims  
1 page Abstract  
6 Sheet(s) of Drawings  
2 page(s) Declaration For Patent Application and Power of Attorney  
1 page(s) Recordation Form Cover Sheet (in duplicate)  
1 page(s) Assignment  
☒ Other: Certified copy of Korean Patent Application No. 2001-25410

**CLAIMS AS FILED**

For	Number Filed		Number Extra		Rate		Basic Fee
Total Claims	20	-20 =	0	x	\$18.00	=	\$ 740.00 \$ 0.00
Independent Claims	3	-3 =	0	x	\$84.00	=	\$ 0.00

Please make the following charges to Deposit Account 19-2386:

- ☒ Total fee for filing the patent application in the amount of \$ 740.00  
☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386.

**EXPRESS MAIL LABEL NO:**

**EL 884 817 420 US**

**December 20, 2001**

Respectfully submitted,

*David W. Heid*

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